

# PPC405EP

Data Sheet

## **PowerPC 405EP Embedded Processor**

#### **Features**

- AMCC PowerPC<sup>®</sup> 405 32-bit RISC processor core operating up to 333MHz with 16KB Dand I-caches
- PC-133 synchronous DRAM (SDRAM) interface
  - 32-bit interface for non-ECC applications
- 4KB on-chip memory (OCM)
- · External peripheral bus
  - Flash ROM/Boot ROM interface
  - Direct support for 8- or 16-bit SRAM and external peripherals
  - Up to five devices
- DMA support for memory and UARTs.
  - Scatter-gather chaining supported
  - Four channels
- PCI Revision 2.2 compliant interface (32-bit, up to 66MHz)

- Asynchronous PCI Bus interface
- Internal or external PCI Bus Arbiter
- Two Ethernet 10/100Mbps (full-duplex) ports with media independent interface (MII)
- Programmable interrupt controller supports seven external and 19 internal edge-triggered or level-sensitive interrupts
- Programmable timers
- · Software accessible event counters
- Two serial ports (16750 compatible UART)
- One IIC interface
- General purpose I/O (GPIO) available
- Supports JTAG for board level testing
- Internal processor local bus (PLB) runs at SDRAM interface frequency
- Supports PowerPC processor boot from PCI memory

### **Description**

Designed specifically to address embedded applications, the PowerPC 405EP (PPC405EP) provides a high-performance, low-power solution that interfaces to a wide range of peripherals by incorporating on-chip power management features and lower power dissipation requirements.

This chip contains a high-performance RISC processor core, SDRAM controller, PCI bus interface,

Ethernet interface, control for external ROM and peripherals, DMA with scatter-gather support, serial ports, IIC interface, and general purpose I/O.

Technology: CMOS SA-27E, 0.18  $\mu$ m (0.11  $\mu$ m L<sub>eff</sub>) Package: 31 mm, 385-ball, enhanced plastic ball grid array (E-PBGA)

Power (typical): 0.72W at 266MHz

## **Revision 1.08 – March 24, 2008**

## PPC405EP – PowerPC 405EP Embedded Processor

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## Ordering, PVR, and JTAG Information

This section provides the part number nomenclature. For availability, contact your local AMCC sales office.

Product Name	Order Part Number <sup>1, 2</sup>	Processor Frequency	Package	Rev Level	PVR Value	JTAG ID
PPC405EP	PPC405EP-3GB133C	133MHz	31 mm, 385 ball E-PBGA	В	0x51210950	0x20267049
PPC405EP	PPC405EP-3GB133CZ	133MHz	31 mm, 385 ball E-PBGA	В	0x51210950	0x20267049
PPC405EP	PPC405EP-3LB133C	133MHz	31 mm, 385 ball E-PBGA	В	0x51210950	0x20267049
PPC405EP	PPC405EP-3LB133CZ	133MHz	31 mm, 385 ball E-PBGA	В	0x51210950	0x20267049
PPC405EP	PPC405EP-3GB200C	200MHz	31 mm, 385 ball E-PBGA	В	0x51210950	0x20267049
PPC405EP	PPC405EP-3GB200CZ	200MHz	31 mm, 385 ball E-PBGA	В	0x51210950	0x20267049
PPC405EP	PPC405EP-3LB200C	200MHz	31 mm, 385 ball E-PBGA	В	0x51210950	0x20267049
PPC405EP	PPC405EP-3LB200CZ	200MHz	31 mm, 385 ball E-PBGA	В	0x51210950	0x20267049
PPC405EP	PPC405EP-3GB266C	266MHz	31 mm, 385 ball E-PBGA	В	0x51210950	0x20267049
PPC405EP	PPC405EP-3GB266CZ	266MHz	31 mm, 385 ball E-PBGA	В	0x51210950	0x20267049
PPC405EP	PPC405EP-3LB266C	266MHz	31 mm, 385 ball E-PBGA	В	0x51210950	0x20267049
PPC405EP	PPC405EP-3LB266CZ	266MHz	31 mm, 385 ball E-PBGA	В	0x51210950	0x20267049
PPC405EP	PPC405EP-3GB333C	333MHz	31 mm, 385 ball E-PBGA	В	0x51210950	0x20267049
PPC405EP	PPC405EP-3GB333CZ	333MHz	31 mm, 385 ball E-PBGA	В	0x51210950	0x20267049
PPC405EP	PPC405EP-3LB333C	333MHz	31 mm, 385 ball E-PBGA	В	0x51210950	0x20267049
PPC405EP	PPC405EP-3LB333CZ	333MHz	31 mm, 385 ball E-PBGA	В	0x51210950	0x20267049

Notes: 1. Z at the end of the Order Part Number indicates a tape and reel shipping package. Otherwise, the chips are shipped in a tray.

2. Package type G contains lead; package type L is lead-free.

The part number contains a part modifier. Included in the modifier is a revision code. This refers to the die mask revision number and is specified in the part numbering scheme for identification purposes only.

The PVR (Processor Version Register) and the JTAG ID register are software accessible (read-only) and contain information that uniquely identifies the part. Refer to the *PowerPC 405EP Embedded Processor User's Manual* for details on accessing these registers.

#### **Order Part Number Key**

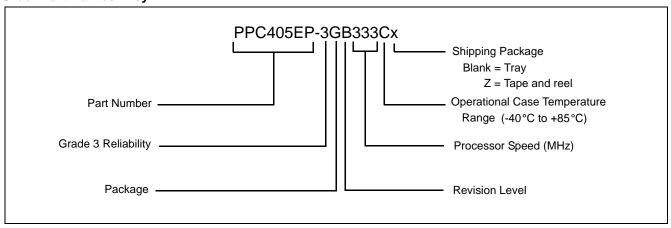
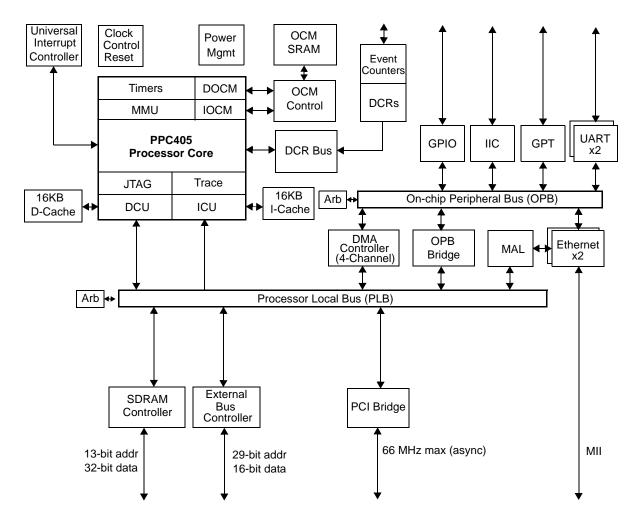


Figure 1. PPC405EP Embedded Controller Functional Block Diagram



The PPC405EP is designed using the IBM Microelectronics Blue Logic<sup>TM</sup> methodology in which major functional blocks are integrated together to create an application-specific ASIC product. This approach provides a consistent way to create complex ASICs using IBM CoreConnect<sup>TM</sup> Bus Architecture.

## **Address Maps**

The PPC405EP incorporates two address maps. The first address map defines the possible use of addressable memory regions that the processor can access. The second address map defines Device Configuration Register (DCR) addresses (numbers). The DCRs are accessed by software running on the PPC405EP processor through the use of **mtdcr** and **mfdcr** instructions.

Table 1. System Memory Address Map (4GB System Memory)

Function	Subfunction	Start Address	End Address	Size
		0x00000000	0xE7FFFFF	3712MB
	SDRAM, External Peripherals, and PCI	0xE8010000	0xE87FFFF	8MB
General Use	Memory National design and the second list and at	0xEC000000	0xEEBFFFFF	44MB
General Ose	<b>Note:</b> Any of the address ranges listed at right may be use for any of the above	0xEEE00000	0xEF3FFFF	6MB
	functions.	0xEF500000	0xEF5FFFF	1MB
		0xEF900000	0xFFFFFFF	263MB
Boot-up	Peripheral Bus Boot <sup>1</sup>	0xFFE00000	0xFFFFFFF	2MB
Воок-ир	PCI Boot <sup>2</sup>	0xFFFE0000	0xFFFFFFF	128KB
	PCI I/O	0xE8000000	0xE800FFFF	64KB
	PCI I/O	0xE8800000	0xEBFFFFFF	56MB
PCI	Configuration Registers	0xEEC00000	0xEEC00007	8B
	Interrupt Acknowledge and Special Cycle	0xEED00000	0xEED00003	4B
	Local Configuration Registers	0xEF400000	0xEF40003F	64B
	GPT	0xEF600000	0xEF6000FF	256B
	UART0	0xEF600300	0xEF600307	8B
	UART1	0xEF600400	0xEF600407	8B
Internal Peripherals	IIC0	0xEF600500	0xEF60051F	32B
internal Feripherals	OPB Arbiter	0xEF600600	0xEF60063F	64B
	GPIO Controller Registers	0xEF600700	0xEF60077F	128B
	Ethernet 0 Controller Registers	0xEF600800	0xEF6008FF	256B
	Ethernet 1 Controller Registers	0xEF600900	0xEF6009FF	256B

#### Notes:

- 1. When peripheral bus boot is selected, peripheral bank 0 is automatically configured at reset to the address range listed above.
- 2. If PCI boot is selected, a PLB-to-PCI mapping is automatically configured at reset to the address range listed above.
- 3. After the boot process, software may reassign the boot memory regions for other uses.
- 4. All address ranges not listed above are reserved.

## Data Sheet

Table 2. DCR Address Map

Function	Start Address	End Address	Size
Total DCR Address Space <sup>1</sup>	0x000	0x3FF	1KW (4KB) <sup>1</sup>
By function:			
Reserved	0x000	0x00F	16W
Memory Controller Registers	0x010	0x011	2W
External Bus Controller Registers	0x012	0x013	2W
Reserved	0x014	0x017	2W
On-Chip Memory Controller Registers	0x018	0x01F	8W
Reserved	0x020	0x07F	96W
PLB Registers	0x080	0x08F	16W
Reserved	0x090	0x09F	16W
OPB Bridge Out Registers	0x0A0	0x0A7	8W
Reserved	0x0A8	0x0AF	6W
Clock, Control, and Reset	0x0B0	0x0B7	8W
Power Management	0x0B8	0x0BF	8W
Interrupt Controller	0x0C0	0x0CF	16W
Reserved	0x0D0	0x0FF	48W
DMA Controller Registers	0x100	0x13F	64W
Reserved	0x140	0x17F	64W
Ethernet MAL Registers	0x180	0x1FF	128W
Event Counters	0x200	0x203	4W
Reserved	0x204	0x3FF	508W

#### Notes:

<sup>1.</sup> DCR address space is addressable with up to 10 bits (1024 or 1K unique addresses). Each unique address represents a single 32-bit (word) register, or 1 kiloword (KW) (which equals 4 KB).

## **On-Chip Memory (OCM)**

The OCM feature comprises a memory controller and a one-port 4KB static RAM (SRAM) accessed by the processor core.

#### Features include:

- Low-latency access to critical instructions and data
- Performance identical to cache hits without misses
- Contents change only under program control

#### **PLB to PCI Interface**

The PLB to PCI interface core provides a mechanism for connecting PCI devices to the local PowerPC processor and local memory. This interface is compliant with version 2.2 of the PCI Specification.

#### Features include:

- internal pci bus arbiter for up to three external devices at PCI bus speeds up to 66MHz. Internal arbiter use is optional and can be disabled for systems which employ an external arbiter.
- PCI bus frequency up to 66MHz
  - Asynchronous operation from 1/8 PLB frequency to 66 MHz maximum
- 32-bit PCI address/data bus
- Power Management:
  - PCI Bus Power Management v1.1 compliant
- Supports 1:1, 2:1, 3:1, 4:1 clock ratios from PLB to PCI
- Buffering between PLB and PCI:
  - PCI target 64-byte write post buffer
  - PCI target 96-byte read prefetch buffer
  - PLB slave 32-byte write post buffer
  - PLB slave 64-byte read prefetch buffer
- Error tracking/status
- Supports PCI target side configuration
- Supports processor access to all PCI address spaces:
  - Single-beat PCI I/O reads and writes
  - PCI memory single-beat and prefetch-burst reads and single-beat writes
  - Single-beat PCI configuration reads and writes (type 0 and type 1)
  - PCI interrupt acknowledge
  - PCI special cycle
- Supports PCI target access to all PLB address spaces
- Supports PowerPC processor boot from PCI memory

### **SDRAM Memory Controller**

The PPC405EP Memory Controller core provides a low latency access path to SDRAM memory. A variety of system memory configurations are supported. The memory controller supports up to two physical banks. Up to 256MB per bank are supported, up to a maximum of 512MB. Memory timings, address and bank sizes, and memory addressing modes are programmable.

#### Features include:

- 11x8 to 13x11 addressing for SDRAM (2 banks)
- · 32-bit memory interface support
- · Programmable address compare for each bank of memory
- Industry standard 168-pin DIMMS are supported (some configurations)
- Up to 133MHz memory supported by the 266MHz processor
- Up to 111 MHz memory supported by the 333 MHz processor
- 4MB to 256MB per bank
- Programmable address mapping and timing
- · Auto refresh
- Page mode accesses with up to 4 open pages
- Power management (self-refresh)

### **External Peripheral Bus Controller (EBC)**

- · Supports five banks of ROM, EPROM, SRAM, Flash memory, or slave peripherals
- Up to 66MHz operation
- · Burst and non-burst devices
- 8- and 16-bit byte-addressable data bus width support
- Latch data on Ready, synchronous or asynchronous
- Programmable 2K clock time-out counter with disable for Ready
- Programmable access timing per device
  - 0-255 wait states for non-bursting devices
  - 0-31 burst wait states for first access and up to 7 wait states for subsequent accesses
  - Programmable CSon, CSoff relative to address
  - Programmable OEon, WEon, WEoff (0 to 3 clock cycles) relative to CS
- Programmable address mapping
- Peripheral Device pacing with external "Ready"

#### **DMA Controller**

- Supports memory-to-memory transfers
- · Four channels
- Scatter/gather capability for programming multiple DMA operations
- 32-bit addressing
- · Address increment or decrement
- Internal 32-byte data buffering capability

#### Serial Interface

- One 8-pin UART and one 2-pin (Tx and Rx only) UART interface provided
- Internal serial clock to allows a wide range of baud rates
- Register compatibility with NS16750 register set
- Complete status reporting capability
- Transmitter and receiver are each buffered with 16-byte FIFOs when in FIFO mode
- Fully programmable serial-interface characteristics
- Supports DMA using internal DMA engine

#### **IIC Bus Interface**

- Compliant with Phillips® Semiconductors I<sup>2</sup>C Specification, dated 1995
- Operation at 100kHz or 400kHz
- 8-bit data
- 10- or 7-bit address
- · Slave transmitter and receiver
- · Master transmitter and receiver
- · Multiple bus masters
- Supports fixed V<sub>DD</sub> IIC interface
- Two independent 4 x 1 byte data buffers
- Twelve memory-mapped, fully programmable configuration registers
- One programmable interrupt request signal
- Provides full management of all IIC bus protocol
- Programmable error recovery

### **General Purpose IO (GPIO) Controller**

- Controller functions and GPIO registers are programmed and accessed via memory-mapped OPB bus master accesses
- All GPIOs are pin-shared with other functions. DCRs control whether a particular pin that has GPIO capabilities acts as a GPIO or is used for another purpose.
- Each GPIO output is separately programmable to emulate an open-drain driver (i.e., drives to zero, three-stated if output bit is 1)

## **Universal Interrupt Controller (UIC)**

The Universal Interrupt Controller (UIC) provides the control, status, and communications necessary between the various sources of interrupts and the local PowerPC processor.

#### Features include:

- Supports seven external and 19 internal interrupts
- Edge-triggered or level-sensitive
- · Positive or negative active
- Non-critical or critical interrupt to processor core
- Programmable critical interrupt priority ordering
- Programmable critical interrupt vector for faster vector processing

## Data Sheet

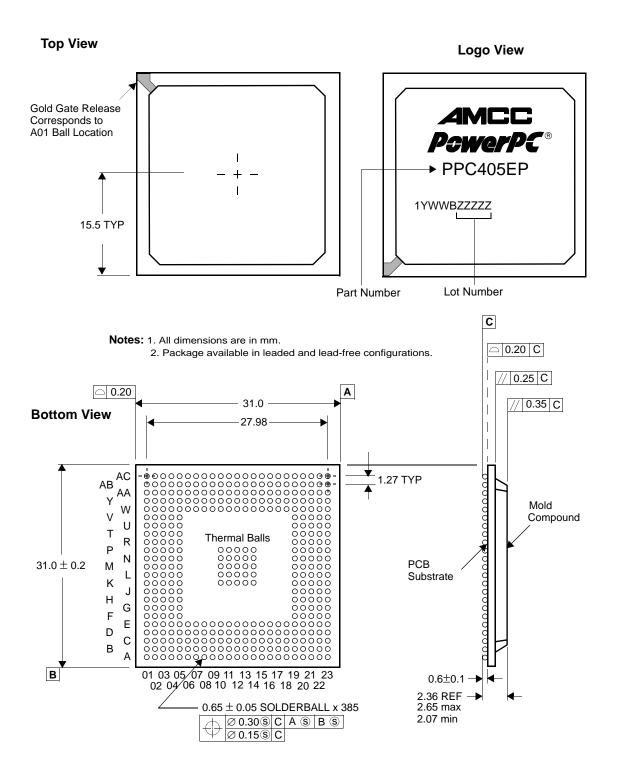
## 10/100 Mbps Ethernet MAC

- Two ports capable of handling full/half duplex 100Mbps and 10Mbps operation
- Uses the medium independent interface (MII) to the physical layer (PHY not included on chip)

## **JTAG**

- IEEE 1149.1 test access port
- IBM RISCWatch debugger support
- JTAG Boundary Scan Description Language (BSDL)

Figure 2. 31mm, 385-Ball E-PBGA Package



## **Pin Lists**

The following table lists all the external signals in alphabetical order and shows the ball (pin) number on which the signal appears. Shared signals are shown with the default signal (following reset) *not* in brackets and the alternate signal in brackets. Shared signals appear alphabetically multiple times in the list—once for each signal assigned to the ball. The page number listed gives the page in "Signal Functional Description" on page 31 where the signals in the indicated interface group begin.

Table 3. Signals Listed Alphabetically (Sheet 1 of 10)

Signal Name	Ball	Interface Group	Page
AGND	AB21	System	25
AV <sub>DD</sub>	AC20		35
BA0	Y15	CDDAM	20
BA1	AC16	SDRAM	33
BankSel0	AB13	SDRAM	33
BankSel1	AC13	SDRAIN	33
CAS	Y14	SDRAM	33
ClkEn0	AB14	SDRAM	33
ClkEn1	AC14	SDRAIN	33
DQM0	AC10		
DQM1	AA7	SDRAM	22
DQM2	W04	SDRAIN	33
DQM3	U02		
EMCMDCIk	Y06	Ethernet	32
EMCMDIO	AA5	Ethernet	32
EMC0Tx0D0	U03		
EMC0Tx0D1	N03	Ethernet	32
EMC0Tx0D2	L01	Ellernet	32
EMC0Tx0D3	P03		
EMC0Tx0En	W01	Ethernet	32
EMC0Tx0Err	V03	Ethernet	32
EMC0Tx1D0	B15		
EMC0Tx1D1	C14	Ethernet	32
EMC0Tx1D2	A15		32
EMC0Tx1D3	D14		
EMC0Tx1En	A16	Ethernet	32
EMC0Tx1Err	C15	Ethernet	32
ExtReset	A03	External Slave Peripheral	33

Table 3. Signals Listed Alphabetically (Sheet 2 of 10)

Signal Name	Ball	Interface Group	Page
GND	A01		
GND	A02		
GND	A07		
GND	A12		
GND	A17		
GND	A22		
GND	A23		
GND	B01		
GND	B02		
GND	B22		
GND	B23		
GND	C03		
GND	C21		
GND	D04	Ground	36
GND	D20	Note: K10-K14, L10-L14, M10-M14, N10-N14, and P10-P14 are also thermal balls.	
GND	E05		
GND	E09		
GND	E12		
GND	E15		
GND	E19		
GND	G01		
GND	G23		
GND	J05		
GND	J19		
GND	K10- K14		
GND	L10- L14		

Table 3. Signals Listed Alphabetically (Sheet 3 of 10)

Signal Name	Ball	Interface Group	Page
GND	M01		
GND	M05		
GND	M10- M14		
GND	M19		
GND	M20		
GND	M23		
GND	N10- N14		
GND	P10- P14		
GND	R05		
GND	R19		
GND	U01		
GND	U23		
GND	W05		
GND	W09		
GND	W12	Power	36
GND	W15	Note: K10-K14, L10-L14, M10-M14, N10-N14, and P10-P14 are also thermal balls.	30
GND	W19		
GND	Y04		
GND	Y20		
GND	AA03		
GND	AA21		
GND	AB01		
GND	AB02		
GND	AB22		
GND	AB23		
GND	AC01		
GND	AC02		
GND	AC07		
GND	AC12		
GND	AC17		
GND	AC22		
GND	AC23		

Table 3. Signals Listed Alphabetically (Sheet 4 of 10)

Signal Name	Ball	Interface Group	Page
GPIO00[PerBLast]	A09		
GPIO01[TS1E]	AA23		
GPIO02[TS2E]	Y22		
GPIO03[TS10]	Y23		
GPIO04[TS20]	W21		
GPIO05[TS3]	U20		
GPIO06[TS4]	V23		
GPIO07[TS5]	U21		
GPIO08[TS6]	U22		
GPIO09[TrcClk]	T21		
GPIO10[PerCS1]	C02		
GPIO11[PerCS2]	E03		
GPIO12[PerCS3]	D03		
GPIO13[PerCS4]	D05		
GPIO14[PerAddr03]	B04		
GPIO15[PerAddr04]	A04	0	0.5
GPIO16[PerAddr05]	A05	System	35
GPIO17[IRQ0]	W22		
GPIO18[IRQ1]	W23		
GPIO19[IRQ2]	V21		
GPIO20[IRQ3]	V22		
GPIO21[IRQ4]	T22		
GPIO22[IRQ5]	R20		
GPIO23[IRQ6]	T23		
GPIO24[UART0_DCD]	M04		
GPIO25[UART0_DSR]	K01		
GPIO26[UART0_RI]	L04		
GPIO27[UART0_DTR]	J01		
GPIO28[UART1_Rx]	J02		
GPIO29[UART1_Tx]	J03		
GPIO30[RejectPkt0]	W20		
GPIO31[RejectPkt1]	Y21		
Halt	C22	System	35
IICSCL	AB4	Internal Darinhard	34
IICSDA	Y01	Internal Peripheral	34
[IRQ0]GPIO17	W22		
[IRQ1]GPIO18	W23		
[IRQ2]GPIO19	V21		
[IRQ3]GPIO20	V22	Interrupts	34
[IRQ4]GPIO21	T22		
[IRQ5]GPIO22	R20		
[IRQ6]GPIO23	T23		

Table 3. Signals Listed Alphabetically (Sheet 5 of 10)

Signal Name	Ball	Interface Group	Page
MemAddr00	AB15		
MemAddr01	AB16		
MemAddr02	AB17		
MemAddr03	AA17		
MemAddr04	AC18		
MemAddr05	AA18		
MemAddr06	AC19	SDRAM  Note: During a CAS cycle MemAddr00 is the least significant bit (lsb) on this bus.	33
MemAddr07	AB19	Note. During a CAS cycle MethAddroo is the least significant bit (ISD) on this bus.	
MemAddr08	Y18		
MemAddr09	AA19		
MemAddr10	Y19		
MemAddr11	AA20		
MemAddr12	AC21		
MemClkOut0	AA14	SUDAM	22
MemClkOut1	Y13	SDRAM	33
MemData00	AB12		
MemData01	AA12		
MemData02	AC11		
MemData03	AA11		
MemData04	Y11		
MemData05	AA10		
MemData06	AC9		
MemData07	AB9		
MemData08	AC8		
MemData09	Y09		
MemData10	AA8		
MemData11	AB7		
MemData12	AB6		
MemData13	Y07		
MemData14	AA6		
MemData15	AC5	SDRAM	33
MemData16	AB5	Note: MemData00 is the most significant bit (msb) on this bus.	33
MemData17	AC4		
MemData18	Y05		
MemData19	AA4		
MemData20	AB3		
MemData21	Y03		
MemData22	W03		
MemData23	V04		
MemData24	W02		
MemData25	U04		
MemData26	V02		
MemData27	T04		
MemData28	T02		
MemData29	R04		
MemData30	R03		
MemData31	R02		

Table 3. Signals Listed Alphabetically (Sheet 6 of 10)

Signal Name	Ball	Interface Group	Page
OV <sub>DD</sub>	B11		
OV <sub>DD</sub>	B09		
OV <sub>DD</sub>	B19		
OV <sub>DD</sub>	C17		
OV <sub>DD</sub>	D13	Power	36
OV <sub>DD</sub>	E06		
$OV_{DD}$	E07		
OV <sub>DD</sub>	E08		
OV <sub>DD</sub>	E16		
OV <sub>DD</sub>	E17		
$OV_{DD}$	E18		
$OV_{DD}$	E21		
$OV_{DD}$	F05		
OV <sub>DD</sub>	F19		
OV <sub>DD</sub>	F23		
$OV_{DD}$	G05		
OV <sub>DD</sub>	G19		
$OV_{DD}$	H05		
$OV_{DD}$	H19		
$OV_{DD}$	H22		
$OV_{DD}$	K04		
OV <sub>DD</sub>	K20		
OV <sub>DD</sub>	K23		
OV <sub>DD</sub>	M22		
OV <sub>DD</sub>	N01		
OV <sub>DD</sub>	P20	Power	36
OV <sub>DD</sub>	P23		
OV <sub>DD</sub>	T05		
OV <sub>DD</sub>	T19		
$OV_{DD}$	T20		
$OV_{DD}$	U05		
OV <sub>DD</sub>	U19		
$OV_{DD}$	V01		
OV <sub>DD</sub>	V05		
$OV_{DD}$	V19		
OV <sub>DD</sub>	W06		
OV <sub>DD</sub>	W07		
OV <sub>DD</sub>	W08		
OV <sub>DD</sub>	W16		
OV <sub>DD</sub>	W17		
OV <sub>DD</sub>	W18		
OV <sub>DD</sub>	Y12		
OV <sub>DD</sub>	AC06		

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Table 3. Signals Listed Alphabetically (Sheet 7 of 10)

Signal Name	Ball	Interface Group	Page
PCIAD00	B16		
PCIAD01	C16		
PCIAD02	B17		
PCIAD03	D16		
PCIAD04	B18		
PCIAD05	D17		
PCIAD06	C18		
PCIAD07	A19		
PCIAD08	D18		
PCIAD09	C19		
PCIAD10	A20		
PCIAD11	B20		
PCIAD12	C20		
PCIAD13	C23	]	
PCIAD14	D21	]	
PCIAD15	D22	PCI	0.1
PCIAD16	J22	Note: PCIAD31 is the most significant bit (msb) on this bus.	31
PCIAD17	J23		
PCIAD18	K21		
PCIAD19	K22		
PCIAD20	L21		
PCIAD21	L22		
PCIAD22	L23		
PCIAD23	M21		
PCIAD24	N23		
PCIAD25	N22		
PCIAD26	N21		
PCIAD27	P22		
PCIAD28	P21		
PCIAD29	R23		
PCIAD30	R22		
PCIAD31	R21		
PCIC0/BE0	A18		
PCIC1/BE1	D19	PCI	31
PCIC2/BE2	L20		31
PCIC3/BE3	N20		
PCICIk	B21	PCI	31
PCIDevSel	H21	PCI	31
PCIFrame	F22	PCI	31
PCIGnt0/Req	D23	PCI	31
PCIGnt1	E23	PCI	31
PCIGnt2	F21	1.51	31
PCIIDSel	A21	PCI	31
PCIINT[PerWE]	D15	PCI	31
PCIIRDY	H20	PCI	31
PCIParity	J21	PCI	31
PCIPErr	H23	PCI	31

Table 3. Signals Listed Alphabetically (Sheet 8 of 10)

Signal Name	Ball	Interface Group	Page
PCIReq0/Gnt	E20		
PCIReq1	F20	PCI	31
PCIReq2	E22		
PCIReset	G20	PCI	31
PCISErr	J20	PCI	31
PCIStop	G22	PCI	31
PCITRDY	G21	PCI	31
[PerAddr03]GPIO14	B04		
[PerAddr04]GPIO15	A04		
[PerAddr05]GPIO16	A05		
PerAddr06	D07		
PerAddr07	B06		
PerAddr08	A06		
PerAddr09	D08		
PerAddr10	C07		
PerAddr11	B07		
PerAddr12	C08		
PerAddr13	B08		
PerAddr14	D09		
PerAddr15	A08		
PerAddr16	C09		
PerAddr17	D10	External Slave Peripheral	33
PerAddr18	C10	Note: PerAddr3 is the most significant bit (msb) on this bus.	
PerAddr19	B10		
PerAddr20	D11		
PerAddr21	A10		
PerAddr22	C11		
PerAddr23	A11		
PerAddr24	D12		
PerAddr25	B12		
PerAddr26	C12		
PerAddr27	A13		
PerAddr28	B13		
PerAddr29	C13		
PerAddr30	A14		
PerAddr31	B14		
[PerBLast]GPIO00	A09	External Slave Peripheral	33
PerClk	C04	External Slave Peripheral	33
PerCS0	E04		
[PerCS1]GPIO10	C02		
[PerCS2]GPIO11	E03	External Slave Peripheral	33
[PerCS3]GPIO12	D03		
[PerCS4]GPIO13	D05		

Table 3. Signals Listed Alphabetically (Sheet 9 of 10)

Ball	Interface Group	Page
P02		
N04		
P01		
M02		
M03		
L02		
L03		
K02	External Slave Peripheral	22
K03	Note: PerData00 is the most significant bit (msb) on this bus.	33
H01		
J04		
G02		
G04		
H04		
F01		
D01		
F04	External Slave Peripheral	33
B03		33
-		33
F03	*	33
	External Slave Peripheral	33
	Ethernet	32
-		
	Ethernet	32
	Ethernet	32
	Ethernet	32
	Ethernet	32
		32
		32
	Laternot	02
-	Ethernet	32
	Ethernet	32
-		32
	Lationiot	52
	Ethernet	32
	System	35
		33
-		35
		35
-	Other	36
	P02 N04 P01 M02 M03 L02 L03 K02 K03 H01 J04 G02 G04 H04 F01 D01 F04 B03 D02	P02

Table 3. Signals Listed Alphabetically (Sheet 10 of 10)

Signal Name	Ball	Interface Group	Page
SysReset	AB20	System	35
TCK	Y02	JTAG	34
TDI	AA1	JTAG	34
TDO	AA2	JTAG	34
TestEn	V20	System	35
TMS	AC3	JTAG	34
TRST	H02	JTAG	34
[TS1E]GPIO01	AA23		
[TS2E]GPIO02	Y22		
[TS10]GPIO03	Y23		
[TS2O]GPIO04	W21	Trace	35
[TS3]GPIO05	U20	Trace	33
[TS4]GPIO06	V23		
[TS5]GPIO07	U21		
[TS6]GPIO08	U22		<u> </u>
[TrcClk]GPIO09	T21	Trace	35
UART0_CTS	T03		
[UART0_DCD]GPIO24	M04		
[UART0_DSR]GPIO25	K01		
[UART0_DTR]GPIO27	J01	Internal Devices	24
[UART0_RI]GPIO26	L04	Internal Peripheral	34
UART0_RTS	N02		
UART0_Rx	T01		
UART0_Tx	P04		
[UART1_Rx]GPIO28	J02	Internal Peripheral	34
[UART1_Tx]GPIO29	J03	internal Feripheral	54
V <sub>DD</sub>	E10		
V <sub>DD</sub>	E11		
V <sub>DD</sub>	E13		
V <sub>DD</sub>	E14		
V <sub>DD</sub>	K05		
V <sub>DD</sub>	K19		
V <sub>DD</sub>	L05		
V <sub>DD</sub>	L19	Power	36
V <sub>DD</sub>	N05		
$V_{DD}$	N19		
$V_{DD}$	P05		
V <sub>DD</sub>	P19		
V <sub>DD</sub>	W10		
V <sub>DD</sub>	W11		
V <sub>DD</sub>	W13		
	W13		
V <sub>DD</sub>		CDDAM	20
WE	AC15	SDRAM	33

Table 4. Signals Listed by Ball Assignment (Sheet 1 of 6)

Ball	Signal Name	Ball	Signal Name	Ball	Signal Name	Ball	Signal Name
A01	GND	B01	GND	C01	PHY0Rx1Err	D01	PerData15
A02	GND	B02	GND	C02	GPIO10[PerCS1]	D02	PerR/W
A03	ExtReset	B03	PerReady	C03	GND	D03	GPIO12[PerCS3]
A04	GPIO15[PerAddr04]	B04	GPIO14[PerAddr03]	C04	PerClk	D04	GND
A05	GPIO16[PerAddr05]	B05	PHY0CrS1	C05	PHY0Col1	D05	GPIO13[PerCS4]
A06	PerAddr08	B06	PerAddr07	C06	PHY0Tx1Clk	D06	PHY0Rx1DV
A07	GND	B07	PerAddr11	C07	PerAddr10	D07	PerAddr06
A08	PerAddr15	B08	PerAddr13	C08	PerAddr12	D08	PerAddr09
A09	GPIO00[PerBLast]	B09	OV <sub>DD</sub>	C09	PerAddr16	D09	PerAddr14
A10	PerAddr21	B10	PerAddr19	C10	PerAddr18	D10	PerAddr17
A11	PerAddr23	B11	OV <sub>DD</sub>	C11	PerAddr22	D11	PerAddr20
A12	GND	B12	PerAddr25	C12	PerAddr26	D12	PerAddr24
A13	PerAddr27	B13	PerAddr28	C13	PerAddr29	D13	OV <sub>DD</sub>
A14	PerAddr30	B14	PerAddr31	C14	EMC0Tx1D1	D14	EMC0Tx1D3
A15	EMC0Tx1D2	B15	EMC0Tx1D0	C15	EMC0Tx1Err	D15	PCIINT[PerWE]
A16	EMC0Tx1En	B16	PCIAD00	C16	PCIAD01	D16	PCIAD03
A17	GND	B17	PCIAD02	C17	OV <sub>DD</sub>	D17	PCIAD05
A18	PCIC0/BE0	B18	PCIAD04	C18	PCIAD06	D18	PCIAD08
A19	PCIAD07	B19	OV <sub>DD</sub>	C19	PCIAD09	D19	PCIC1/BE1
A20	PCIAD10	B20	PCIAD11	C20	PCIAD12	D20	GND
A21	PCIIDSel	B21	PCICIk	C21	GND	D21	PCIAD14
A22	GND	B22	GND	C22	Halt	D22	PCIAD15
A23	GND	B23	GND	C23	PCIAD13	D23	PCIGnt0/Req

Table 4. Signals Listed by Ball Assignment (Sheet 2 of 6)

Ball	Signal Name						
E01	PerWBE1	F01	PerData14	G01	GND	H01	PerData09
E02	PHY0Rx1Clk	F02	PHY0Rx1D3	G02	PerData11	H02	TRST
E03	GPIO11[PerCS2]	F03	PerWBE0	G03	PHY0Rx1D2	H03	PHY0Rx1D1
E04	PerCS0	F04	PerOE	G04	PerData12	H04	PerData13
E05	GND	F05	OV <sub>DD</sub>	G05	OV <sub>DD</sub>	H05	OV <sub>DD</sub>
E06	OV <sub>DD</sub>	F06	No ball	G06	No ball	H06	No ball
E07	OV <sub>DD</sub>	F07	No ball	G07	No ball	H07	No ball
E08	OV <sub>DD</sub>	F08	No ball	G08	No ball	H08	No ball
E09	GND	F09	No ball	G09	No ball	H09	No ball
E10	V <sub>DD</sub>	F10	No ball	G10	No ball	H10	No ball
E11	V <sub>DD</sub>	F11	No ball	G11	No ball	H11	No ball
E12	GND	F12	No ball	G12	No ball	H12	No ball
E13	V <sub>DD</sub>	F13	No ball	G13	No ball	H13	No ball
E14	V <sub>DD</sub>	F14	No ball	G14	No ball	H14	No ball
E15	GND	F15	No ball	G15	No ball	H15	No ball
E16	OV <sub>DD</sub>	F16	No ball	G16	No ball	H16	No ball
E17	OV <sub>DD</sub>	F17	No ball	G17	No ball	H17	No ball
E18	OV <sub>DD</sub>	F18	No ball	G18	No ball	H18	No ball
E19	GND	F19	OV <sub>DD</sub>	G19	OV <sub>DD</sub>	H19	OV <sub>DD</sub>
E20	PCIReq0/Gnt	F20	PCIReq1	G20	PCIReset	H20	PCIIRDY
E21	OV <sub>DD</sub>	F21	PCIGnt2	G21	PCITRDY	H21	PCIDevSel
E22	PCIReq2	F22	PCIFrame	G22	PCIStop	H22	OV <sub>DD</sub>
E23	PCIGnt1	F23	OV <sub>DD</sub>	G23	GND	H23	PCIPErr

Table 4. Signals Listed by Ball Assignment (Sheet 3 of 6)

Ball	Signal Name	Ball	Signal Name	Ball	Signal Name	Ball	Signal Name
J01	GPIO27[UART0_DTR]	K01	GPIO25[UART0_DSR]	L01	EMC0Tx0D2	M01	GND
J02	GPIO28[UART1_Rx]	K02	PerData07	L02	PerData05	M02	PerData03
J03	GPIO29[UART1_Tx]	K03	PerData08	L03	PerData06	M03	PerData04
J04	PerData10	K04	OV <sub>DD</sub>	L04	GPIO26[UART0_RI]	M04	GPIO24[UART0_DCD]
J05	GND	K05	V <sub>DD</sub>	L05	V <sub>DD</sub>	M05	GND
J06	No ball	K06	No ball	L06	No ball	M06	No ball
J07	No ball	K07	No ball	L07	No ball	M07	No ball
J08	No ball	K08	No ball	L08	No ball	M08	No ball
J09	No ball	K09	No ball	L09	No ball	M09	No ball
J10	No ball	K10	GND	L10	GND	M10	GND
J11	No ball	K11	GND	L11	GND	M11	GND
J12	No ball	K12	GND	L12	GND	M12	GND
J13	No ball	K13	GND	L13	GND	M13	GND
J14	No ball	K14	GND	L14	GND	M14	GND
J15	No ball	K15	No ball	L15	No ball	M15	No ball
J16	No ball	K16	No ball	L16	No ball	M16	No ball
J17	No ball	K17	No ball	L17	No ball	M17	No ball
J18	No ball	K18	No ball	L18	No ball	M18	No ball
J19	GND	K19	$V_{DD}$	L19	$V_{DD}$	M19	GND
J20	PCISErr	K20	OV <sub>DD</sub>	L20	PCIC2/BE2	M20	GND
J21	PCIParity	K21	PCIAD18	L21	PCIAD20	M21	PCIAD23
J22	PCIAD16	K22	PCIAD19	L22	PCIAD21	M22	OV <sub>DD</sub>
J23	PCIAD17	K23	OV <sub>DD</sub>	L23	PCIAD22	M23	GND

Table 4. Signals Listed by Ball Assignment (Sheet 4 of 6)

Ball	Signal Name	Ball	Signal Name	Ball	Signal Name	Ball	Signal Name
N01	OV <sub>DD</sub>	P01	PerData02	R01	PHY0Rx1D0	T01	UART0_Rx
N02	UARTO_RTS	P02	PerData00	R02	MemData31	T02	MemData28
N03	EMC0Tx0D1	P03	EMC0Tx0D3	R03	MemData30	T03	UARTO_CTS
N04	PerData01	P04	UART0_Tx	R04	MemData29	T04	MemData27
N05	V <sub>DD</sub>	P05	V <sub>DD</sub>	R05	GND	T05	OV <sub>DD</sub>
N06	No ball	P06	No ball	R06	No ball	T06	No ball
N07	No ball	P07	No ball	R07	No ball	T07	No ball
N08	No ball	P08	No ball	R08	No ball	T08	No ball
N09	No ball	P09	No ball	R09	No ball	T09	No ball
N10	GND	P10	GND	R10	No ball	T10	No ball
N11	GND	P11	GND	R11	No ball	T11	No ball
N12	GND	P12	GND	R12	No ball	T12	No ball
N13	GND	P13	GND	R13	No ball	T13	No ball
N14	GND	P14	GND	R14	No ball	T14	No ball
N15	No ball	P15	No ball	R15	No ball	T15	No ball
N16	No ball	P16	No ball	R16	No ball	T16	No ball
N17	No ball	P17	No ball	R17	No ball	T17	No ball
N18	No ball	P18	No ball	R18	No ball	T18	No ball
N19	V <sub>DD</sub>	P19	V <sub>DD</sub>	R19	GND	T19	OV <sub>DD</sub>
N20	PCIC3/BE3	P20	OV <sub>DD</sub>	R20	GPIO22[IRQ5]	T20	OV <sub>DD</sub>
N21	PCIAD26	P21	PCIAD28	R21	PCIAD31	T21	GPIO09[TrcClk]
N22	PCIAD25	P22	PCIAD27	R22	PCIAD30	T22	GPIO21[IRQ4]
N23	PCIAD24	P23	OV <sub>DD</sub>	R23	PCIAD29	T23	GPIO23[IRQ6]

Table 4. Signals Listed by Ball Assignment (Sheet 5 of 6)

Ball	Signal Name	Ball	Signal Name	Ball	Signal Name	Ball	Signal Name
U01	GND	V01	OV <sub>DD</sub>	W01	EMC0Tx0En	Y01	IICSDA
U02	DQM3	V02	MemData26	W02	MemData24	Y02	тск
U03	EMC0Tx0D0	V03	EMC0Tx0Err	W03	MemData22	Y03	MemData21
U04	MemData25	V04	MemData23	W04	DQM2	Y04	GND
U05	OV <sub>DD</sub>	V05	OV <sub>DD</sub>	W05	GND	Y05	MemData18
U06	No ball	V06	No ball	W06	OV <sub>DD</sub>	Y06	EMC0MDClk
U07	No ball	V07	No ball	W07	OV <sub>DD</sub>	Y07	MemData13
U08	No ball	V08	No ball	W08	OV <sub>DD</sub>	Y08	PHY0Tx0Clk
U09	No ball	V09	No ball	W09	GND	Y09	MemData09
U10	No ball	V10	No ball	W10	V <sub>DD</sub>	Y10	PHY0Rx0DV
U11	No ball	V11	No ball	W11	V <sub>DD</sub>	Y11	MemData04
U12	No ball	V12	No ball	W12	GND	Y12	OV <sub>DD</sub>
U13	No ball	V13	No ball	W13	V <sub>DD</sub>	Y13	MemClkOut1
U14	No ball	V14	No ball	W14	V <sub>DD</sub>	Y14	CAS
U15	No ball	V15	No ball	W15	GND	Y15	BA0
U16	No ball	V16	No ball	W16	OV <sub>DD</sub>	Y16	PHY0Rx0D0
U17	No ball	V17	No ball	W17	OV <sub>DD</sub>	Y17	SysErr
U18	No ball	V18	No ball	W18	OV <sub>DD</sub>	Y18	MemAddr08
U19	OV <sub>DD</sub>	V19	OV <sub>DD</sub>	W19	GND	Y19	MemAddr10
U20	GPIO05[TS3]	V20	TestEn	W20	GPIO30[RejectPkt0]	Y20	GND
U21	GPIO07[TS5]	V21	GPIO19[IRQ2]	W21	GPI004[TS20]	Y21	GPIO31[RejectPkt1]
U22	GPIO08[TS6]	V22	GPIO20[IRQ3]	W22	GPIO17[IRQ0]	Y22	GPIO02[TS2E]
U23	GND	V23	GPIO06[TS4]	W23	GPIO18[IRQ1]	Y23	GPI003[TS10]

## Data Sheet

Table 4. Signals Listed by Ball Assignment (Sheet 6 of 6)

Ball	Signal Name	Ball	Signal Name	Ball	Signal Name	Ball	Signal Name
AA01	TDI	AB01	GND	AC01	GND		
AA02	TDO	AB02	GND	AC02	GND		
AA03	GND	AB03	MemData20	AC03	TMS		
AA04	MemData19	AB04	IICSCL	AC04	MemData17		
AA05	EMC0MDIO	AB05	MemData16	AC05	MemData15		
AA06	MemData14	AB06	MemData12	AC06	OV <sub>DD</sub>		
AA07	DQM1	AB07	MemData11	AC07	GND		
AA08	MemData10	AB08	PHY0Col0	AC08	MemData08		
AA09	PHY0CrS0	AB09	MemData07	AC09	MemData06		
AA10	MemData05	AB10	PHY0Rx0Clk	AC10	DQM0		
AA11	MemData03	AB11	PHY0Rx0Err	AC11	MemData02		
AA12	MemData01	AB12	MemData00	AC12	GND		
AA13	PHY0Rx0D3	AB13	BankSel0	AC13	BankSel1		
AA14	MemClkOut0	AB14	ClkEn0	AC14	ClkEn1		
AA15	RAS	AB15	MemAddr00	AC15	WE		
AA16	PHY0Rx0D2	AB16	MemAddr01	AC16	BA1		
AA17	MemAddr03	AB17	MemAddr02	AC17	GND		
AA18	MemAddr05	AB18	SysClk	AC18	MemAddr04		
AA19	MemAddr09	AB19	MemAddr07	AC19	MemAddr06		
AA20	MemAddr11	AB20	SysReset	AC20	AV <sub>DD</sub>		
AA21	GND	AB21	AGND	AC21	MemAddr12		
AA22	PHY0Rx0D1	AB22	GND	AC22	GND		
AA23	GPIO01[TS1E]	AB23	GND	AC23	GND		

### **Signal List**

The following table provides a summary of the number of package pins associated with each functional interface group.

Table 5. Pin Summary

Group	No. of Pins
Non multiplexed	215
Multiplexed	33
Total Signal Pins	248
$OV_DD$	43
$V_{DD}$	16
Gnd	53
Thermal (and Gnd)	25
Reserved	0
Total Pins	385

In the table "Signal Functional Description" on page 31, each external signal is listed along with a short description of the signal function. Active-low signals (for example, RAS) are marked with an overline. Please see "Signals Listed Alphabetically" on page 13 for the pin (ball) number to which each signal is assigned.

#### **Multiplexed Pins**

Some signals are multiplexed on the same package pin (ball) so that the pin can be used for different functions. In most cases, the signal names shown in this table are not accompanied by signal names that may be multiplexed on the same pin. If you need to know what, if any, signals are multiplexed with a particular signal, look up the name in "Signals Listed Alphabetically" on page 13. It is expected that in any single application a particular pin will always be programmed to serve the same function. The flexibility of multiplexing allows a single chip to offer a richer pin selection than would otherwise be possible.

In addition to multiplexing, many pins are also multi-purpose. For example, in the PCI interface PCIC3:0/BE3:0 serves as both Command and Byte Enable signals. In this example, the pins are also bidirectional, serving as both inputs and outputs.

#### Initialization Strapping

One group of pins is used as strapped inputs during system reset. These pins function as strapped inputs only during reset and are used for other functions during normal operation (see "Initialization" on page 49). Note that the use of these pins for strapping is not considered multiplexing since the strapping function is not programmable.

#### **Pull-Up and Pull-Down Resistors**

Pull-up and pull-down resistors are used for strapping during reset and to retain unused or undriven inputs in an appropriate state. The recommended pull-up value of  $3k\Omega$  to +3.3V ( $10k\Omega$  to +5V can be used on 5V tolerant I/Os) and pull-down value of  $1k\Omega$  to GND, applies only to individually terminated signals. To prevent possible damage to the device, I/Os capable of becoming outputs *must never* be tied together and terminated through a common resistor.

If your system-level test methodology permits, input-only signals can be connected together and terminated through either a common resistor or directly to +3.3V or GND. When a resistor is used, its value must ensure that the grouped I/Os reach a valid logic zero or logic one state when accounting for the total input current into the PPC405EP.

#### Unused I/Os

Strapping of some pins may be necessary when they are unused. Although the PPC405EP requires only the pull-up and pull-down terminations as specified in the "Signal Functional Description" on page 31, good design practice is to terminate all unused inputs or to configure I/Os such that they always drive. If unused, the peripheral, SDRAM, and PCI buses should be configured and terminated as follows:

- Peripheral interface—PerAddr03:31, PerData00:15, and all of the control signals are driven by default. Pull
  up PerReady.
- SDRAM—Program SDRAM0\_CFG[EMDULR]=1 and SDRAM0\_CFG[DCE]=1. This causes the PPC405EP to actively drive all of the SDRAM address, data, and control signals.
- PCI—The PCI pull-up requirements given in the Signal Functional Description apply only when the PCI interface is being used. When the PCI bridge is unused, configure the PCI controller to park on the bus and actively drive PCIAD31:00, PCIC3:0/BE3:0, and the remaining PCI control signals by doing the following:
  - Strap the PPC405EP to disable the internal PCI arbiter.
  - Individually pull up PCISErr, PCIPErr, PCITRDY, and PCIStop through 3.3kΩ resistors to +3.3V.
  - Pull up PCIReq1:2 through a 3.3kΩ resistor to +3.3V.
  - Pull down  $\overline{PCIReq0}/\overline{Gnt}$  through a 1k $\Omega$  resistor to GND.

#### **External Bus Control Signals**

All peripheral bus control signals (PerCS0:4, PerR/W, PerWBE0:1, PerOE, PerWE, PerBLast) are set to the high-impedance state when ExtReset = 0. In addition, as detailed in the *PowerPC 405EP Embedded Processor User's Manual*, the peripheral bus controller can be programmed via EBC0\_CFG to float some of these control signals between transactions. As a result, a pull-up resistor should be added to those control signals where an undriven state may affect any devices receiving that particular signal.

The following table lists all of the I/O signals provided by the PPC405EP. Please refer to "Signals Listed Alphabetically" on page 13 for the pin number to which each signal is assigned.

## Table 6. Signal Functional Description (Sheet 1 of 6)

Secondary multiplexed signals are shown in brackets.

#### Notes:

- 1. Receiver input has hysteresis.
- 2. Must pull up. See "Pull-Up and Pull-Down Resistors" on page 29 for recommended termination values.
- 3. Must pull down. See "Pull-Up and Pull-Down Resistors" on page 29 for recommended termination values.
- 4. If not used, must pull up.
- 5. If not used, must pull down.
- 6. Strapping input during reset; pull up or pull down as required.
- 7. Pull-up may be required. See "External Bus Control Signals" on page 30.

Signal Name	Description	I/O	Туре	Notes
PCI Interface				
PCIAD00:31	PCI Address/Data Bus. Multiplexed address and data bus.  Note: The target device number is driven on PCIAD11:31 for PCI Type 0 configuration transactions.  Connect the target IDSEL associated with device: 1 to PCIAD16 2 to PCIAD17 21 to PCIAD31.	I/O	5V tolerant 3.3V PCI	
PCIC3:0/BE3:0	PCI bus command and byte enables.	I/O	5V tolerant 3.3V PCI	
PCICIk	PCICIk is used as the asynchronous PCI clock when in asynch mode.	I	5V tolerant 3.3V PCI	
PCIFrame	PCIFrame is driven by the current PCI bus master to indicate the beginning and duration of a PCI access.	I/O	5V tolerant 3.3V PCI	2
PCIParity	PCI parity. Parity is even across PCIAD00:31 and PCIC3:0/BE3:0. PCIParity is valid one cycle after either an address or data phase. The PCI device that drove PCIAD00:31 is responsible for driving PCIParity on the next PCI bus clock.	I/O	5V tolerant 3.3V PCI	
PCIIRDY	PCIIRDY is driven by the current PCI bus master. Assertion of PCIIRDY indicates that the PCI initiator is ready to transfer data.	I/O	5V tolerant 3.3V PCI	2
PCITRDY	The target of the current PCI transaction drives PCITRDY. Assertion of PCITRDY indicates that the PCI target is ready to transfer data.	I/O	5V tolerant 3.3V PCI	2
PCIStop	The target of the current PCI transaction can assert PCIStop to indicate to the requesting PCI master that it wants to end the current transaction.	I/O	5V tolerant 3.3V PCI	2
PCIDevSel	PCIDevSel is driven by the target of the current PCI transaction. A PCI target asserts PCIDevSel when it has decoded an address and command encoding and claims the transaction.	I/O	5V tolerant 3.3V PCI	2
PCIIDSel	PCIIDSel is used during configuration cycles to select the PCI slave interface for configuration.	ı	5V tolerant 3.3V PCI	
PCIINT	PCI interrupt. Open-drain output (two states; 0 or open circuit) or Peripheral write enable. Low when any of the four PerWBE0:3 write byte enables are low.	0	5V tolerant 3.3V PCI	
PCISErr	PCISErr is used for reporting address parity errors or catastrophic failures detected by a PCI target.	I/O	5V tolerant 3.3V PCI	2
PCIPErr	PCIPErr is used for reporting data parity errors on PCI transactions. PCIPErr is driven active by the device receiving PCIAD00:31, PCIC3:0/BE3:0, and PCIParity, two PCI clocks following the data in which bad parity is detected.	I/O	5V tolerant 3.3V PCI	2
PCIReset	PCI specific reset.	0	5V tolerant 3.3V PCI	
PCIReq0/Gnt	Multipurpose signal, used as PCIReq0 when internal arbiter is used, and as Gnt when external arbiter is used.	ı	5V tolerant 3.3V PCI	

## Table 6. Signal Functional Description (Sheet 2 of 6)

Secondary multiplexed signals are shown in brackets.

#### Notes:

- 1. Receiver input has hysteresis.
- 2. Must pull up. See "Pull-Up and Pull-Down Resistors" on page 29 for recommended termination values.
- 3. Must pull down. See "Pull-Up and Pull-Down Resistors" on page 29 for recommended termination values.
- 4. If not used, must pull up.
- 5. If not used, must pull down.
- 6. Strapping input during reset; pull up or pull down as required.
- 7. Pull-up may be required. See "External Bus Control Signals" on page 30.

Signal Name	Description	1/0	Туре	Notes
PCIReq1:2	PCIReq input when internal arbiter is used.	I	5V tolerant 3.3V PCI	
PCIGnt0/Req	Gnt0 when internal arbiter is used or Req when external arbiter is used.	0	5V tolerant 3.3V PCI	
PCIGnt1:2	PCIGnt output when internal arbiter is used.	0	5V tolerant 3.3V PCI	
Ethernet Interface				
PHY0Rx0:1D3:0	Received data. This is a nibble wide bus from the PHY. The data is synchronous with the PHY0RxClk.	I	5V tolerant 3.3V LVTTL	1
EMC0Tx0:1D3:0	Transmit data. A nibble wide data bus towards the net. The data is synchronous to the PHY0TxClk.	0	5V tolerant 3.3V LVTTL	
PHY0Rx0:1Err	Receive Error. This signal comes from the PHY and is synchronous to the PHY0RxClk.	ı	5V tolerant 3.3V LVTTL	1
PHY0Rx0:1Clk	Receive Medium clock. This signal is generated by the PHY. If an EMAC interface is not used, this clock must be present in order to reset the EMAC.	I	5V tolerant 3.3V LVTTL	1
PHY0Rx0:1DV	Receive Data Valid. Data on the Data Bus is valid when this signal is activated. Deassertion of this signal indicates end of the frame reception.	I	5V tolerant 3.3V LVTTL	1
PHY0CrS0:1	Carrier Sense signal from the PHY. This is an asynchronous signal.	I	5V tolerant 3.3V LVTTL	1
EMC0Tx0:1Err	Transmit Error. This signal is generated by the Ethernet controller, is connected to the PHY and is synchronous with the PHYTxClk. It informs the PHY that an error was detected.	0	5V tolerant 3.3V LVTTL	
EMC0Tx0:1En	Transmit Enable. This signal is driven by the EMAC to the PHY. Data is valid during the active state of this signal. Deassertion of this signal indicates end of frame transmission. This signal is synchronous to the PHY0TxClk.	0	5V tolerant 3.3V LVTTL	
PHY0Tx0:1Clk	This clock comes from the PHY and is the Medium Transmit clock. If an EMAC interface is not used, this clock must be present in order to reset the EMAC.	I	5V tolerant 3.3V LVTTL	1
PHY0Col0:1	Collision signal from the PHY. This is an asynchronous signal.	ı	5V tolerant 3.3V LVTTL	1
EMC0MDClk	Management Data Clock. The MDClk is sourced to the PHY. Management information is transferred synchronously with respect to this clock.	0	5V tolerant 3.3V LVTTL	
EMCOMDIO	Management Data Input/Output is a bidirectional signal between the Ethernet controller and the PHY. It is used to transfer control and status information.	I/O	5V tolerant 3.3V LVTTL	1

## Table 6. Signal Functional Description (Sheet 3 of 6)

Secondary multiplexed signals are shown in brackets.

#### Notes:

- 1. Receiver input has hysteresis.
- 2. Must pull up. See "Pull-Up and Pull-Down Resistors" on page 29 for recommended termination values.
- 3. Must pull down. See "Pull-Up and Pull-Down Resistors" on page 29 for recommended termination values.
- 4. If not used, must pull up.
- 5. If not used, must pull down.
- 6. Strapping input during reset; pull up or pull down as required.
- 7. Pull-up may be required. See "External Bus Control Signals" on page 30.

Signal Name	Description	1/0	Туре	Notes
DRAM Interface				
MemData00:31	Memory data bus.  Notes:  1. MemData00 is the most significant bit (msb).  2. MemData31 is the least significant bit (lsb).		3.3V LVTTL	
MemAddr12:00	Memory address bus.  Notes:  1. MemAddr12 is the most significant bit (msb).  2. MemAddr00 is the least significant bit (lsb).		3.3V LVTTL	
BA1:0	Bank Address supporting up to 4 internal banks.	0	3.3V LVTTL	
RAS	Row Address Strobe.	0	3.3V LVTTL	
CAS	Column Address Strobe.	0	3.3V LVTTL	
DQM0:3	DQM for byte lane: 0 (MemData00:7), 1 (MemData08:15), 2 (MemData16:23), and 3 (MemData24:31)		3.3V LVTTL	
BankSel0:1	Select up to two external SDRAM banks.	0	3.3V LVTTL	
WE	Write Enable.	0	3.3V LVTTL	
ClkEn0:1	SDRAM Clock Enable.	0	3.3V LVTTL	
MemClkOut0:1	Two copies of an SDRAM clock allows, in some cases, glueless SDRAM attach without requiring this signal to be repowered by a PLL or zero-delay buffer.		3.3V LVTTL	
ternal Slave Perip	heral Interface			
PerData00:15	Peripheral data bus.  Note: PerData00 is the most significant bit (msb) on this bus.	I/O	5V tolerant 3.3V LVTTL	1
PerAddr03:05 PerAddr06:31	Peripheral address bus.  Note: PerAddr03 is the most significant bit (msb) on this bus.	I/O	5V tolerant 3.3V LVTTL	1
PerWBE0:1	These pins act as byte-enables which are valid for an entire cycle or as write-byte-enables which are valid for each byte on each data transfer, allowing partial word transactions.	0	5V tolerant 3.3V LVTTL	7
[PerWE]	Peripheral write enable. Low when either of the two PerWBE0:1 write byte enables are low.  To access this function, software must toggle a DCR bit.		5V tolerant 3.3V LVTTL	
PerCS0	Peripheral chip select bank 0.		5V tolerant 3.3V LVTTL	7
[PerCS1:4]	Four additional peripheral chip selects To access this function, software must toggle a DCR bit.		5V tolerant 3.3V LVTTL	1, 7
PerOE	Peripheral output enable.	0	5V tolerant 3.3V LVTTL	7
PerR/W	Peripheral read/write. High indicates a read from memory, low indicates a write to memory.	0	5V tolerant 3.3V LVTTL	

### Table 6. Signal Functional Description (Sheet 4 of 6)

Secondary multiplexed signals are shown in brackets.

#### Notes:

- 1. Receiver input has hysteresis.
- 2. Must pull up. See "Pull-Up and Pull-Down Resistors" on page 29 for recommended termination values.
- 3. Must pull down. See "Pull-Up and Pull-Down Resistors" on page 29 for recommended termination values.
- 4. If not used, must pull up.
- 5. If not used, must pull down.
- 6. Strapping input during reset; pull up or pull down as required.
- 7. Pull-up may be required. See "External Bus Control Signals" on page 30.

Signal Name	Description	1/0	Туре	Notes
PerReady	Ready to transfer data.	1	5V tolerant 3.3V LVTTL	1
[PerBLast]	Used to indicates the last transfer of a memory access.  To access this function, software must toggle a DCR bit.		5V tolerant 3.3V LVTTL	1, 7
PerClk	Peripheral clock to be used by peripheral slaves.		5V tolerant 3.3V LVTTL	
ExtReset	Reset Peripheral reset to be used by peripheral slaves.		5V tolerant 3.3V LVTTL	
Internal Peripheral In	terface			
UART0_Rx	UART0 Serial Data In.	1	5V tolerant 3.3V LVTTL	1
UART0_Tx	UART0 Serial Data Out.	0	5V tolerant 3.3V LVTTL	6
[UART0_DCD]	UART0 Data Carrier Detect. To access this function, software must toggle a DCR bit.	I	5V tolerant 3.3V LVTTL	1
[UART0_DSR]	UART0 Data Set Ready. To access this function, software must toggle a DCR bit.		5V tolerant 3.3V LVTTL	1
UART0_CTS	UART0 Clear To Send.	1	5V tolerant 3.3V LVTTL	1
[UART0_DTR]	UART0 Data Terminal Ready. To access this function, software must toggle a DCR bit.	0	5V tolerant 3.3V LVTTL	
UART0_RTS	UART0 Request To Send.	0	5V tolerant 3.3V LVTTL	6
[UART0_RI]	UART0 Ring Indicator. To access this function, software must toggle a DCR bit.	1	5V tolerant 3.3V LVTTL	1
[UART1_Rx]	UART1 Serial Data In. To access this function, software must toggle a DCR bit.	ı	5V tolerant 3.3V LVTTL	1
[UART1_Tx]	[UART1_Tx]  UART1 Serial Data Out.  To access this function, software must toggle a DCR bit.		5V tolerant 3.3V LVTTL	
IICSCL	IICSCL IIC Serial Clock.		3.3V IIC	1, 2
IICSDA	IIC Serial Data.	I/O	3.3V IIC	1, 2
Interrupts Interface		•		
[IRQ0:6]	Interrupt requests To access this function, software must toggle a DCR bit.	1	5V tolerant 3.3V LVTTL	1
JTAG Interface		•		
TDI	Test data in.	I	5V tolerant 3.3V LVTTL	1, 4
TMS	JTAG test mode select.	1	5V tolerant 3.3V LVTTL	1, 4

## Table 6. Signal Functional Description (Sheet 5 of 6)

Secondary multiplexed signals are shown in brackets.

#### Notes:

- 1. Receiver input has hysteresis.
- 2. Must pull up. See "Pull-Up and Pull-Down Resistors" on page 29 for recommended termination values.
- 3. Must pull down. See "Pull-Up and Pull-Down Resistors" on page 29 for recommended termination values.
- 4. If not used, must pull up.
- 5. If not used, must pull down.
- 6. Strapping input during reset; pull up or pull down as required.
- 7. Pull-up may be required. See "External Bus Control Signals" on page 30.

Signal Name	Signal Name Description		Туре	Notes
TDO	Test data out.		5V tolerant 3.3V LVTTL	
TCK	JTAG test clock. The frequency of this input can range from DC to 25MHz.		5V tolerant 3.3V LVTTL	1, 4
TRST	JTAG reset. TRST must be low at power-on to initialize the JTAG controller.		5V tolerant 3.3V LVTTL	5
System Interface				
SysReset	Main system reset. External logic can drive this bidirectional pin low (minimum of 16 cycles) to initiate a system reset. A system reset can also be initiated by software. Implemented as an open-drain output (two states; 0 or open circuit).		5V tolerant 3.3V LVTTL	1, 2
SysErr	Set to 1 when a Machine Check is generated.		5V tolerant 3.3V LVTTL	6
Halt	Halt from external debugger.	ı	5V tolerant 3.3V LVTTL	1, 2
GPIO00:31	General Purpose I/O. All of the GPIO signals are multiplexed with other signals.	I/O	5V tolerant 3.3V LVTTL	1
TestEn	Test Enable. Used only for manufacturing tests. Pull down for normal operation.	ı	1.8V CMOS w/pull-down	
SysClk	Main system clock input.		3.3V LVTTL	
[RejectPkt0:1]	External request to reject a packet.	I	5V tolerant 3.3V LVTTL	
AV <sub>DD</sub>	Clean voltage input for the PLL.			
AGND	Clean Ground input for the PLL.	I		
Trace Interface				
[TS1E] [TS2E]	Even Trace execution status. To access this function, software must toggle a DCR bit		5V tolerant 3.3V LVTTL	1
[TS10] [TS20]	Odd Trace execution status. To access this function, software must toggle a DCR bit		5V tolerant 3.3V LVTTL	1
[TS3:6]	Trace status. To access this function, software must toggle a DCR bi		5V tolerant 3.3V LVTTL	1
[TrcClk]	[TrcClk] Trace interface clock. Operates at half the CPU core frequency. To access this function, software must toggle a DCR bit		5V tolerant 3.3V LVTTL	1

### Table 6. Signal Functional Description (Sheet 6 of 6)

Secondary multiplexed signals are shown in brackets.

#### Notes:

- 1. Receiver input has hysteresis.
- 2. Must pull up. See "Pull-Up and Pull-Down Resistors" on page 29 for recommended termination values.
- 3. Must pull down. See "Pull-Up and Pull-Down Resistors" on page 29 for recommended termination values.
- 4. If not used, must pull up.
- 5. If not used, must pull down.
- 6. Strapping input during reset; pull up or pull down as required.
- 7. Pull-up may be required. See "External Bus Control Signals" on page 30.

Signal Name	Description		Туре	Notes	
Power					
GND	Ground  Note: K10-K14, L10-L14, M10-M14, N10-N14, and P10-P14 are also na thermal balls.		na		
OV <sub>DD</sub>	Output driver voltage—3.3V.	⇒–3.3V. na na		na	
V <sub>DD</sub>	Logic voltage—1.8V.		na	na	
Other pins					
Reserved pins. Do not make voltage, ground, or signal connections to these pins.		na	na	na	

#### Table 7. Absolute Maximum Ratings

The absolute maximum ratings below are stress ratings only. Operation at or beyond these maximum ratings can cause permanent damage to the device. None of the performance specification contained in this document are guaranteed when operating at these maximum ratings.

Characteristic	Symbol	Value	Unit
Supply Voltage (Internal Logic)	V <sub>DD</sub>	0 to +1.95	V
Supply Voltage (I/O Interface)	OV <sub>DD</sub>	0 to +3.6	V
PLL Supply Voltage	AV <sub>DD</sub>	0 to +1.95	V
Input Voltage (1.8 V CMOS receivers)	V <sub>IN</sub>	0 to +1.95	V
Input Voltage (3.3V LVTTL receivers)	V <sub>IN</sub>	0 to +3.6	V
Input Voltage (5.0 V LVTTL receivers)	V <sub>IN</sub>	0 to +5.5	V
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C
Case temperature under bias	T <sub>C</sub>	-40 to +120	°C

Note: All specified voltages are with respect to GND.

# Table 8. Package Thermal Specifications

The PPC405EP is designed to operate within a case temperature range of -40°C to +85°C. Thermal resistance values for the E-PBGA packages in a convection environment are as follows:

Package—Thermal Resistance	Symbol		Unit		
-	-	0 (0)	100 (0.51)	200 (1.02)	
31 mm, 385-balls—Junction-to-Case	$\theta_{\sf JC}$	2	2	2	°C/W
31mm, 385-balls—Case-to-Ambient <sup>1</sup>	$\theta_{\sf CA}$	17.8	16.8	16.1	°C/W

#### Note:

- 1. For a chip mounted on a JEDEC 2S2P card without a heat sink.
- 2. For a chip mounted on a card with at least one signal and two power planes, the following relationships exist:
  - a. Case temperature,  $T_C$ , is measured at top center of case surface with device soldered to circuit board.
  - b.  $T_A = T_C P \times \theta_{CA}$ , where  $T_A$  is ambient temperature and P is power consumption.
  - c.  $T_{CMax} = T_{JMax} P \times \theta_{JC}$ , where  $T_{JMax}$  is maximum junction temperature and P is power consumption.

## Table 9. Recommended DC Operating Conditions (Sheet 1 of 2)

Device operation beyond the conditions specified is not recommended. Extended operation beyond the recommended conditions can affect device reliability.

### Notes:

- 1. PCI drivers meet PCI specifications.
- 2. See "5V-Tolerant Input Current" on page 39.

Parameter	Symbol	Minimum	Typical	Maximum	Unit	Notes
Logic Supply Voltage (133, 200, 266MHz)	$V_{DD}$	+1.65	+1.8	+1.95	V	
Logic Supply Voltage (333MHz)	V <sub>DD</sub>	+1.7	+1.8	+1.9	V	
I/O Supply Voltage	OV <sub>DD</sub>	+3.0	+3.3	+3.6	V	
PLL Supply Voltage (133, 200, 266MHz)	AV <sub>DD</sub>	+1.65	+1.8	+1.95	V	
PLL Supply Voltage (333MHz)	AV <sub>DD</sub>	+1.7	+1.8	+1.9	V	
Input Logic High (1.8V CMOS receivers)	V <sub>IH</sub>	0.65V <sub>DD</sub>		V <sub>DD</sub>	V	
Input Logic High (3.3 V PCI receivers)	V <sub>IH</sub>	0.5OV <sub>DD</sub>		OV <sub>DD</sub> +0.5	V	
Input Logic High (3.3V LVTTL, 5V tolerant receivers)	V <sub>IH</sub>	+2.0		+5.5	V	
Input Logic Low (1.8V CMOS receivers)	V <sub>IL</sub>	0		0.65V <sub>DD</sub>	V	
Input Logic Low (3.3 V PCI receivers)	V <sub>IL</sub>	-0.5		0.35OV <sub>DD</sub>	V	
Input Logic Low (3.3V LVTTL, 5V tolerant receivers)	V <sub>IL</sub>	0		+0.8	V	
Output Logic High (3.3V PCI receivers)	V <sub>OH</sub>	0.90V <sub>DD</sub>		OV <sub>DD</sub>	V	
Output Logic High (3.3V LVTTL, 5V tolerant receivers)	V <sub>OH</sub>	+2.4		OV <sub>DD</sub>	V	
Output Logic Low (3.3 V PCI receivers)	V <sub>OL</sub>	-0.5		0.35OV <sub>DD</sub>	V	
Output Logic Low (3.3V LVTTL, 5V tolerant receivers)	V <sub>OL</sub>	0		+0.4	V	

## Table 9. Recommended DC Operating Conditions (Sheet 2 of 2)

Device operation beyond the conditions specified is not recommended. Extended operation beyond the recommended conditions can affect device reliability.

## Notes:

- 1. PCI drivers meet PCI specifications.
- 2. See "5V-Tolerant Input Current" on page 39.

Parameter	Symbol	Minimum	Typical	Maximum	Unit	Notes
Input Leakage Current (no pull-up or pull-down)	I <sub>IL1</sub>	0		0	μΑ	
Input Leakage Current (with internal pull-down)	I <sub>IL2</sub>	0		200	μΑ	
5V Tolerant I/O Input Current	I <sub>IL4</sub>	±10		-325	μΑ	2
Input Max Allowable Overshoot (1.8V CMOS receivers)	V <sub>IMAO1.8</sub>			V <sub>DD</sub> + 0.6	V	
Input Max Allowable Overshoot (3.3V LVTTL, 5V tolerant receivers)	V <sub>IMAO</sub>			+5.5	V	
Input Max Allowable Undershoot (3.3V LVTTL, 5V tolerant receivers)	V <sub>IMAU</sub>	-0.6			V	
Output Max Allowable Overshoot (3.3V LVTTL, 5V tolerant receivers)	V <sub>OMAO</sub>			+5.5	V	
Output Max Allowable Undershoot (3.3V LVTTL, 5V tolerant receivers)	V <sub>OMAU</sub>	-0.6			V	
Case Temperature	T <sub>C</sub>	-40		+85	°C	

Figure 3. 5V-Tolerant Input Current

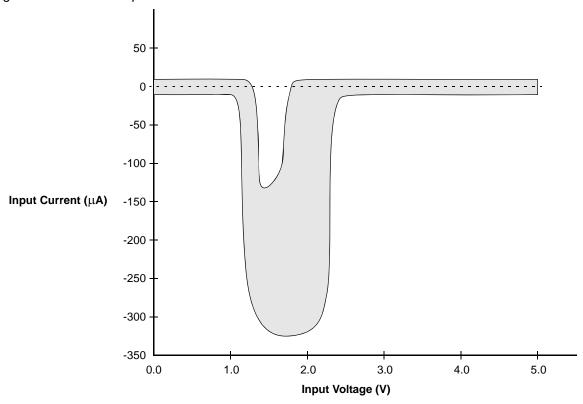


Table 10. Input Capacitance

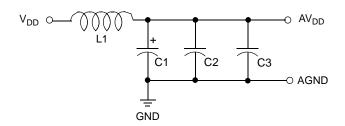
Parameter	Symbol	Maximum	Unit	Notes
3.3V LVTTL I/O	C <sub>IN1</sub>	12	pF	
5V tolerant, 3.3V LVTTL I/O	C <sub>IN2</sub>	12	pF	
PCI I/O	C <sub>IN3</sub>	12	pF	
Rx only pins	C <sub>IN4</sub>	9	pF	
IIC pads	C <sub>IN5</sub>	6.7	pF	

Table 11. DC Electrical Characteristics

Parameter	Symbol	Minimum	Typical	Maximum	Unit
Active Operating Current (V <sub>DD</sub> )–266MHz	I <sub>DD</sub>		300	610	mA
Active Operating Current (V <sub>DD</sub> )-333MHz			325	690	mA
Active Operating Current (OV <sub>DD</sub> )			45	200	mA
PLL V <sub>DD</sub> Input current	PLL V <sub>DD</sub> Input current I <sub>PLL</sub>		16	23	mA
Active Operating Power–266 MHz	P <sub>DD</sub>		0.72	1.92	W
Active Operating Power–333MHz	P <sub>DD</sub>		0.76	2.07	W

### Note:

- 1. The maximum current and power values listed above are not guaranteed to be the highest obtainable. These values are dependent on many factors including the type of applications running, clock rates, use of internal functional capabilities, external interface usage, case temperature, and the power supply voltages. Your specific application can produce significantly different results. V<sub>DD</sub> (logic) current and power are primarily dependent on the applications running and the use of internal chip functions (DMA, PCI, Ethernet, and so on). OV<sub>DD</sub> (I/O) current and power are primarily dependent on the capacitive loading, frequency, and utilization of the external buses. The following information provides details about the conditions under which the values in the table above could be obtained:
  - a. In general, there would be four PCI devices, an external bus master on the peripheral bus, and external wrap-back on the Ethernet port. For I<sub>ODD</sub> measurements, PLB = 133.3MHz, OPB = PerClk = 66.6MHz, and PCI = SysClk = 33.3MHz.
  - b. Typical current and power are characterized at  $V_{DD}$  = +1.8 V,  $OV_{DD}$  = +3.3 V, and  $T_{C}$  = +36 °C while running various applications under the Linux operating system.
  - c. Maximum current and power are characterized at V<sub>DD</sub> = +1.9V, OV<sub>DD</sub> = +3.6V, and T<sub>C</sub> = +85°C while running applications designed to maximize CPU power consumption. An external PCI master heavily loads the PCI bus with transfers targeting SDRAM while the internal DMA controller further increases SDRAM bus traffic.
- 2.  $AV_{DD}$  should be derived from  $V_{DD}$  using the following circuit:



- L1 2.2 μH SMT inductor (equivalent to MuRata LQH3C2R2M34) or SMT chip ferrite bead (equivalent to MuRata BLM31A700S)
- $C1 3.3 \mu F$  SMT tantalum
- C2 0.1 μF SMT monolithic ceramic capacitor with X7R dielectric or equivalent
- $C3 0.01 \, \mu F$  SMT monolithic ceramic capacitor with X7R dielectric or equivalent

# Data Sheet

## **Test Conditions**

Clock timing and switching characteristics are specified in accordance with operating conditions shown in the table "Recommended DC Operating Conditions." For all signals other than PCI signals, AC specifications are characterized at  $\rm OV_{DD}=3V$  and  $\rm T_{C}=85\,^{\circ}C$  with the 50pF test load shown in the figure at right.

For PCI signals there are two different test load circuits, one for the rising edge and one the falling edge as shown in the figures at right.

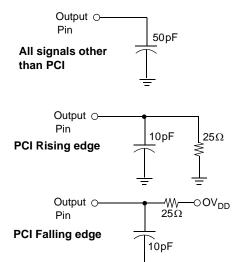
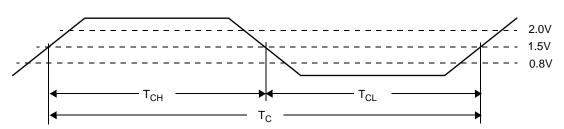


Table 12. Clocking Specifications

Symbol	Parameter	Min	Max	Units
CPU			_	_
$PF_C$	Processor clock frequency		133.33, 200, 266.66, or 333.33	MHz
PT <sub>C</sub>	Processor clock period	7.5, 5, 3.75 or 3		ns
SysClk Input				
SCF <sub>C</sub>	Frequency	25	100	MHz
SCT <sub>C</sub>	Period	10	40	ns
$SCT_{CS}$	Edge stability (phase jitter, cycle to cycle)	-	±0.15	ns
SCT <sub>CH</sub>	Input high time	40% of nominal period	60% of nominal period	ns
SCT <sub>CL</sub>	Input low time	40% of nominal period	60% of nominal period	ns
Note: Input slev	w rate > 2V/ns			
MemClkOut Ou	tput			_
$MCOF_C$	Frequency		PLBF <sub>C</sub>	MHz
$MCOT_C$	Period	1/PLBF <sub>C</sub>		ns
$MCOT_CS$	Edge stability (phase jitter, cycle to cycle)	-	±0.2	ns
MCOT <sub>CH</sub>	Output high time	45% of nominal period	55% of nominal period	ns
MCOT <sub>CL</sub>	Output low time	45% of nominal period	55% of nominal period	ns
TrcClk Output				
TCF <sub>C</sub>	Clock output frequency		PF <sub>C</sub> /2	MHz
TCT <sub>C</sub>	Clock period		PT <sub>C</sub> x2	ns
TCT <sub>CS</sub>	Clock edge stability (phase jitter, cycle to cycle)		± 0.2	ns
TCT <sub>CH</sub>	Clock output high time	45% of nominal period	55% of nominal period	ns
TCT <sub>CL</sub>	Clock output low time	45% of nominal period	55% of nominal period	ns
Other Clocks		<u> </u>		
VCOF <sub>C</sub>	VCO frequency @ PF <sub>C</sub> = 133, 200, or 266MHz	500	1000	MHz
VCOF <sub>C</sub>	VCO frequency @ PF <sub>C</sub> = 333MHz	500	1333	MHz
PLBF <sub>C</sub>	PLB frequency @ PF <sub>C</sub> = 266.66MHz	66.66	133.33	MHz
PLBF <sub>C</sub>	PLB frequency @ PF <sub>C</sub> = 333.33MHz	55.55	111.11	MHz
PLBF <sub>C</sub>	PLB frequency @ PF <sub>C</sub> = 200MHz	50	100	MHz
OPBF <sub>C</sub>	OPB frequency @ PF <sub>C</sub> = 133.33MHz	8.33	66.66	MHz
OPBF <sub>C</sub>	OPB frequency @ PF <sub>C</sub> = 266.66MHz	16.66	66.66	MHz
OPBF <sub>C</sub>	OPB frequency @ PF <sub>C</sub> = 333.33MHz	13.87	55.55	MHz
OPBF <sub>C</sub>	OPB frequency @ PF <sub>C</sub> = 200MHz	12.5	50	MHz

Figure 4. Clocking Waveform



# **Spread Spectrum Clocking**

Care must be taken when using a spread spectrum clock generator (SSCG) with the PPC405EP. This controller uses a PLL for clock generation inside the chip. The accuracy with which the PLL follows the SSCG is referred to as tracking skew. The PLL bandwidth and phase angle determine how much tracking skew there is between the SSCG and the PLL for a given frequency deviation and modulation frequency. When using an SSCG with the PPC405EP the following conditions must be met:

- The frequency deviation must not violate the minimum clock cycle time. Therefore, when operating the PPC405EP with one or more internal clocks at their maximum supported frequency, the SSCG can only lower the frequency.
- The maximum frequency deviation cannot exceed –3%, and the modulation frequency cannot exceed 40kHz. In some cases, on-board PPC405EP peripherals impose more stringent requirements (see Note 1).
- Use the peripheral bus clock (PerClk) for logic that is synchronous to the peripheral bus since this clock tracks the modulation.
- Use the SDRAM MemClkOut since it also tracks the modulation.

### Notes:

- The serial port baud rates are synchronous to the modulated clock. The serial port has a tolerance of approximately 1.5% on baud rate before framing errors begin to occur. The 1.5% tolerance assumes that the connected device is running at precise baud rates. If an external serial clock is used the baud rate is unaffected by the modulation.
- 2. Operation of the PPC405EP PCI Bridge is unaffected by the use of an SSCG.
  - The PCI controller must be operated in asynchronous mode. When in asynchronous mode, the PCI bus clock must be driven into the PPC405EP PCICIk input. In this configuration the PCI controller supports the 66.66 MHz PCI clock specification which specifies a maximum frequency deviation of -1% at a modulation of between 30 kHz and 33 kHz.
- 3. Ethernet operation is unaffected.
- 4. IIC operation is unaffected.

**Caution:** It is up to the system designer to ensure that any SSCG used with the PPC405EP meets the above requirements and does not adversely affect other aspects of the system.

# Data Sheet

Table 13. Peripheral Interface Clock Timings

Parameter	Min	Max	Units
PCICIk input frequency (asynchronous mode)	Note 1	66.66	MHz
PCICIk period (asynchronous mode)	15	Note 1	ns
PCICIk input high time	40% of nominal period	60% of nominal period	ns
PCICIk input low time	40% of nominal period	60% of nominal period	ns
EMC0MDClk output frequency	-	2.5	MHz
EMC0MDClk period	400	-	ns
EMC0MDClk output high time	160	-	ns
EMC0MDClk output low time	160	-	ns
PHY0Tx0:1Clk input frequency	2.5	25	MHz
PHY0Tx0:1Clk period	40	400	ns
PHY0Tx0:1Clk input high time	35% of nominal period	-	ns
PHY0Tx0:1Clk input low time	35% of nominal period	-	ns
PHY0Rx0:1Clk input frequency	2.5	25	MHz
PHY0Rx0:1Clk period	40	400	ns
PHY0Rx0:1Clk input high time	35% of nominal period	-	ns
PHY0Rx0:1Clk input low time	35% of nominal period	-	ns
PerClk output frequency	-	66.66	MHz
PerClk period	15	-	ns
PerClk output high time	45% of nominal period	55% of nominal period	ns
PerClk output low time	45% of nominal period	55% of nominal period	ns
PerClk clock edge stability (phase jitter, cycle to cycle)		± 0.3	ns

### Note:

<sup>1.</sup> In asynchronous PCI mode the minimum PCIClk frequency is 1/8 the PLB Clock. Refer to the *PowerPC 405EP Embedded Processor User's Manual* for more information.

Figure 5. Input Setup and Hold Timing Waveform

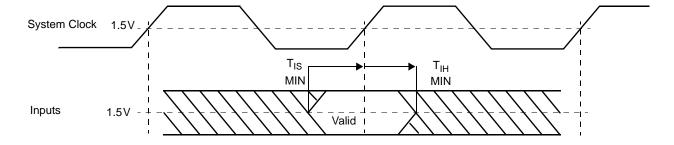


Figure 6. Output Delay and Float Timing Waveform

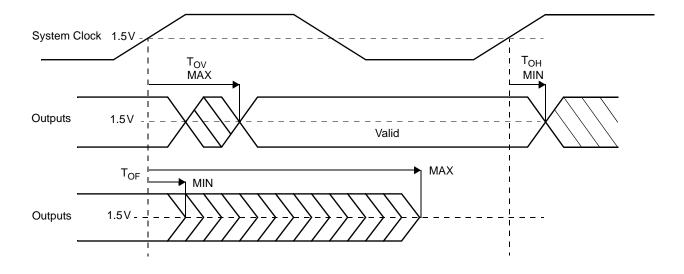


Table 14. I/O Specifications—Group 1 (Sheet 1 of 2)

#### Notes:

- 1. PCI timings are for asynchronous operation up to 66.66MHz. PCI output hold time requirement is 1 ns for 66.66MHz and 2ns for 33.33MHz.
- 2. Ethernet interface meets timing requirements as defined by IEEE 802.3 standard. Timing shown is with EMAC noise filter selected. See the CPC0\_EPCTL register *PowerPC 405EP Embedded Processor User's Manual.*
- 3. For PCI,  $I_{OH}$  is specified at  $0.90V_{DD}$  and  $I_{OL}$  is specified at  $0.10V_{DD}$ . For all other interfaces,  $I_{OH}$  is specified at 2.4V and  $I_{OL}$  is specified at 0.4V.

	Inpu	t (ns)	Outpu	ıt (ns)	Output Cu	ırrent (mA)		
Signal	Setup Time (T <sub>IS</sub> min)	Hold Time (T <sub>IH</sub> min)	Valid Delay (T <sub>OV</sub> max)	Hold Time (T <sub>OH</sub> min)	I <sub>OH</sub> (min)	I <sub>OL</sub> (min)	Clock	Notes
PCI Interface								
PCIAD31:00	3	0	6	1	0.5	1.5	PCICIk	1
PCIC3:0/BE3:0	3	0	6	1	0.5	1.5	PCICIk	1
PCICIk	na	na	na	na	na	na	async	
PCIDevSel	3	0	6	1	0.5	1.5	PCICIk	1
PCIFrame	3	0	6	1	0.5	1.5	PCICIk	1
PCIGnt0/Req PCIGnt1:2	na	na	6	1	0.5	1.5	PCICIk	1
PCIIDSel	3	0	na	na	na	na	PCICIk	1
PCIINT[PerWE]	na	na	na	na	0.5	1.5	PCICIk	1
PCIIRDY	3	0	6	1	0.5	1.5	PCICIk	1
PCIParity	3	0	6	1	0.5	1.5	PCICIk	1
PCIPErr	3	0	6	1	0.5	1.5	PCICIk	1
PCIReq0/Gnt PCIReq1:2	5	0	na	na	na	na	PCICIk	1
PCIReset	na	na	na	na	0.5	1.5	PCICIk	1
PCISErr	na	na	na	na	0.5	1.5	PCICIk	1
PCIStop	3	0	6	1	0.5	1.5	PCICIk	1
PCITRDY	3	0	6	1	0.5	1.5	PCICIk	1
Ethernet Interface								
EMC0MDClk	na	na	settable	2	10.3	7.1	async	2
EMC0MDIO	na	na	na	na	10.3	7.1	EMC0MDClk	2
EMC0Tx0:1D3:0	na	na	14	5	10.3	7.1	PHY0TxClk	2
EMC0Tx0:1En	na	na	14	5	10.3	7.1	PHY0TxClk	2
EMC0Tx0:1Err	na	na	14	5	10.3	7.1	PHY0TxClk	2
PHY0Col0:1	2	3	na	na	na	na	PHY0RxClk	2
PHY0CrS0:1	2	3	na	na	na	na	PHY0RxClk	2
PHY0Rx0:1Clk	na	na	na	na	na	na	async	2
PHY0Rx0:1D3:0	2	4	na	na	na	na	PHY0RxClk	2
PHY0Rx0:1DV	2	4	na	na	na	na	PHY0RxClk	2
PHY0Rx0:1Err	2	4	na	na	na	na	PHY0RxClk	2
PHY0Tx0:1Clk	na	na	na	na	na	na	async	2

Table 14. I/O Specifications—Group 1 (Sheet 2 of 2)

#### Notes:

- 1. PCI timings are for asynchronous operation up to 66.66MHz. PCI output hold time requirement is 1 ns for 66.66MHz and 2ns for 33.33MHz.
- 2. Ethernet interface meets timing requirements as defined by IEEE 802.3 standard. Timing shown is with EMAC noise filter selected. See the CPC0\_EPCTL register *PowerPC 405EP Embedded Processor User's Manual.*
- 3. For PCI,  $I_{OH}$  is specified at 0.90V<sub>DD</sub> and  $I_{OL}$  is specified at 0.10V<sub>DD</sub>. For all other interfaces,  $I_{OH}$  is specified at 2.4V and  $I_{OL}$  is specified at 0.4V.

	Input	t (ns)	Outpu	ıt (ns)	Output Cu	ırrent (mA)		
Signal	Setup Time (T <sub>IS</sub> min)	Hold Time (T <sub>IH</sub> min)	Valid Delay (T <sub>OV</sub> max)	Hold Time (T <sub>OH</sub> min)	I <sub>OH</sub> (min)	I <sub>OL</sub> (min)	Clock	Notes
Internal Peripheral Inte	erface							
IICSCL	na	na	na	na	15.3	10.2		
IICSDA	na	na	na	na	15.3	10.2		
UART0_CTS	na	na	na	na	na	na		
UART0_RTS	na	na	na	na	10.3	7.1		
UART0_Rx	na	na	na	na	na	na		
UART0_Tx	na	na	na	na	10.3	7.1		
UART1_Rx	na	na	na	na	na	na		
UART1_Tx	na	na	na	na	10.3	7.1		
Interrupts Interface								
[IRQ0:6]					10.3	7.1		
JTAG Interface								
TCK	na	na	na	na	na	na	async	
TDI	na	na	na	na	na	na	async	
TDO	na	na	na	na	10.3	7.1	async	
TMS	na	na	na	na	na	na	async	
TRST	na	na	na	na	na	na	async	
System Interface								
GPIO00:31	na	na	na	na	10.3	7.1		
Halt	na	na	na	na	na	na	async	
SysErr	na	na	na	na	10.3	7.1	async	
SysReset	na	na	na	na	10.3	7.1	async	
TestEn	na	na	na	na	na	na	async	
[RejectPkt0:1]	3	1	na	na	na	na	async	
SysClk	na	na	na	na	na	na		

# Table 15. I/O Specifications—Group 2

### Notes:

- 1. The SDRAM command interface is configurable through SDRAM0\_TR[LDF] to provide a 2 to 4 cycle delay before the command is used by SDRAM.
- 2. SDRAM I/O timings are specified relative to a MemClkOut terminated into a lumped 10pF load.
- 3. SDRAM interface hold times are guaranteed at the PPC405EP package pin. System designers must use the PPC405EP IBIS model (available from **www.amcc.com**) to ensure their clock distribution topology minimizes loading and reflections, and that the relative delays on clock wiring do not exceed the delays on other SDRAM signal wiring.
- 4. PerClk rising edge at package pin with a 10pF load trails the internal PLB clock by approximately 0.8ns.
- 5. I<sub>OH</sub> is specified at 2.4V and I<sub>OL</sub> is specified at 0.4V.

	Input (ns) Output (ns) Output Current (mA)		ıt (ns)	Output Cu	rrent (mA)			
Signal	Setup Time (T <sub>IS</sub> min)	Hold Time (T <sub>IH</sub> min)	Valid Delay (T <sub>OV</sub> max)	Hold Time (T <sub>OH</sub> min)	I <sub>OH</sub> (minimum)	I <sub>OL</sub> (minimum)	Clock	Notes
SDRAM Interface								
BA1:0	na	na	4.7	2	15.3	10.2	MemClkOut	1, 2
BankSel3:0	na	na	4.5	1.7	15.3	10.2	MemClkOut	1, 2
CAS	na	na	4.8	2	15.3	10.2	MemClkOut	1, 2
ClkEn0:1	na	na	4.1	1.6	28.7	19.3	MemClkOut	1, 2
DQM0:3	na	na	4.7	1.9	15.3	10.2	MemClkOut	1, 2
MemAddr12:00	na	na	4.8	2.1	15.3	10.2	MemClkOut	1, 2
MemData00:31	1.6	1	4	1.2	15.3	10.2	MemClkOut	1, 2
RAS	na	na	5	2.1	15.3	10.2	MemClkOut	1, 2
WE	na	na	4.9	2	15.3	10.2	MemClkOut	1, 2
External Slave Periphe	ral Interface							
PerAddr06:31	na	na	3.8	1.6	15.3	10.2	PerClk	
[PerBLast]	4	1	8	0	12	8	PerClk	
PerCS0 [PerCS1:4]	na	na	4.1	1.5	10.3	7.1	PerClk	
PerData00:31	5	1	6.4	1.5	15.3	10.2	PerClk	
PerOE	na	na	4.1	1.5	10.3	7.1	PerClk	
PerR/W	na	na	4.1	1.6	10.3	7.1	PerClk	
PerReady	6.5	1	na	na	na	na	PerClk	
PerWBE0:3	na	na	4.1	1.6	10.3	7.1	PerClk	
ExtReset	na	na	na	na	15.3	10.2	PerClk	
PerClk	na	na	0.4	-0.2	15.3	10.2	PLB Clk	4

## Initialization

The following describes the method by which initial chip settings are established when a system reset occurs.

## Strapping

When the  $\overline{\text{SysReset}}$  input is driven low (system reset), the state of certain I/O pins is read to enable default initial conditions prior to PPC405EP start-up. The actual capture instant is the nearest system clock edge before the deassertion of reset. These pins must be strapped using external pull-up (logical 1) or pull-down (logical 0) resistors to select the desired default conditions. The recommended pull-up is  $3k\Omega$  to +3.3V or  $10k\Omega$  to +5V. The recommended pull-down is  $1K\Omega$  to GND. These pins are use for strap functions only during reset. They are used for other signals during normal operation. The following table lists the strapping pins along with their functions and strapping options. The signal names assigned to the pins for normal operation appear below the pin number.

Table 16. Strapping Pin Assignments

Function	Option	Ball Str	apping
IIC EEPROM controller If the controller is enabled, 32 bytes of configuration data		<b>P04</b> UART0_Tx	
are read from the EEPROM.	Disable	0	
	Enable	1	
EEPROM address (P04 = 1) or Boot ROM width (P04 = 0)		N02 UARTO_RTS	<b>Y17</b> SysErr
When P04 = 1, these pins set the high-order two bits of the EEPROM base address.	High order EEPROM base address bits	Address bit	Address bit
When P04 = 0, these pins indicated the width of	8 bits	0	0
the boot ROM.	16 bits	0	1
	reserved	1	0
	reserved	1	1

### **EEPROM**

During reset, configuration values other than the internal default values can be read from a serial EEPROM connected to the IIC port. The association of bits in the EEPROM with the configuration values and their default values are covered in detail in the *PowerPC 405EP Embedded Processor User's Manual*.

**Note:** If P04 is strapped to 1, and the EEPROM is not connected or is defective, the PPC405EP remains in the reset state and will not boot.

# **Document Revision History**

Revision	Date	Description
1.01	07/30/04	Initial Release
1.02	01/10/05	Add lead-free part numbers and clean up AMCC conversion.
1.03	05/01/07	Add information on connection of target device IDSEL to the addess bus.  Modify description of TRST signal.  Remove note on TrcClk concerning initilization.
1.04	06/01/07	Update package thickness values (package drawing). Add Logo View to package drawing.
1.05	07/18/07	Add instructions to PHY clock signals indicating they must be present even if interface is not used.
1.06	09/06/07	Correct AMCC phone numbers.
1.07	09/10/07	Change TestEn signal from active low to active high.
1.08	03/24/08	Delete EMC0MDIO I/O timing (Doc Issue 496).



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